

**PATENT** Attorney Docket No. SAM-0126

## THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): In-Jung Lee, et al.

Serial No.:

09/633,366

Examiner: Nguyen, C.

Group Art Unit: 2811

Filing Date: Title:

August 7, 2000 CAPACITOR AND FABRICATING METHOD THEREFOR

CERTIFICATE OF MAILING UNDER 37 C.F.R. § 1.8

I hereby certify that this correspondence is being deposited with the United States Post Office as First Class Mail on the date indicated below in an envelope addressed to BOX NON-FEE AMENDMENT, Assistant Commissioner for Patents, Washington, DC 20231.

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**Assistant Commissioner for Patents** 

Washington, D.C. 20231

AMENDMENT A

Sir:

This is in response to the Office Action mailed on February 25, 2002.

Please amend the application as follows:

In the Claims

(Amended) A semiconductor capacitor having a lower electrode, a dielectric layer and an upper electrode, wherein the upper electrode comprises a deposition structure including three layers including a doped polysilicon layer formed between a first undoped polysilicon layer and a second undoped polysilicon layer.